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Recent advances on spinel-based protective coatings for solid oxide cell metallic interconnects produced by electrophoretic deposition

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(Article begins on next page)

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Materials Letters

Recent advances on spinel-based protective coatings for solid oxide cell metallic interconnects produced by electrophoretic deposition

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Abstract:	The application of ceramic protective coatings to the metallic interconnects in solid oxide cells (SOC) is a viable and effective method to limit interconnect degradation issues. This featured letter provides a critical overview of the main outcomes of current research on the use of the electrophoretic deposition (EPD) technique to produce protective coatings for SOC metallic interconnects, specifically focusing on different approaches to stabilise spinel-based suspensions, as well as the possible sintering procedures. The protective properties of EPD coatings are reviewed and discussed in terms of oxidation kinetics and area specific resistance evaluation.

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Cover Letter

POLITECNICO
DI TORINO
Department of Applied Science and Technology

Prof. Federico Smeacetto, PhD
Associate Professor of Materials Science and Technology

Torino, December 14th, 2020

To the Editor of ***Materials Letters***

OBJECT: Submission of the revised version of featured letter **"Recent advances on spinel-based protective coatings for solid oxide cell metallic interconnects produced by electrophoretic deposition"**

Dear Editor,

We have considered the Reviewers' comments to our paper, enclosed in your e-mail message of November 27th, 2020.

First of all, we wish to thank you and the reviewers for the attention dedicated to the revision of the paper. We have reviewed the paper taking into account the Reviewer's comments; reviewed parts are highlighted in track changes mode in the revised manuscript.

We sincerely hope that this featured letter can be published on your Journal to have a wide diffusion through the Scientific Community.

Thank you for your kind attention.

Best Regards,

Federico Smeacetto,

on behalf of all Authors

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Reviewer #1: In this study, authors described Recent advances on spinel-based protective coatings for solid oxide cell metallic interconnects produced by electrophoretic deposition. Paper well written and well characterized and recommend for publication. Below correction need before final acceptance

The authors would like to thank the reviewer for acknowledging our work and for the comments and suggestions.

1) English level of paper must be improve

R: We have revised the manuscript and we have improved the English level of the paper.

2) More data must be add

R: As suggested by the reviewer we have added more data in the following parts: "2.1 EPD of manganese-cobalt and manganese-copper spinel":

Page 3 "-i.e. ethanol (EtOH), acetone (ACE), isopropanol (IPA), acetylacetone (ACAC) and their mixtures-"

Page 3 "of almost 5 times"

Page 3 "(i.e. 40 vol.%)"

Page 3 "from partially aqueous suspension"

Page 3 "(60 V more often)"

Page 4 :"Suspensions of Mn-Cu spinel can be stabilised by employing fully organic liquid media with addition of I2 in significant concentration (i.e. 1.09 g/l); compared to EPD of Mn-Co spinel; depositions take place at lower applied voltage (20 V against 50-60 V), but remarkably longer time (10 min against 20-60 s)."

3) Conclusion must be improve with more data

R: As suggested by the reviewer we have improved the conclusion section.

The following sentence has been added to the paragraph "5, page 10. Future perspectives and concluding remarks":

: "Future research should investigate more deeply the links between deposition method, coating composition and long-term performances, especially for IT-SOC and using low-cost interconnect alloys".

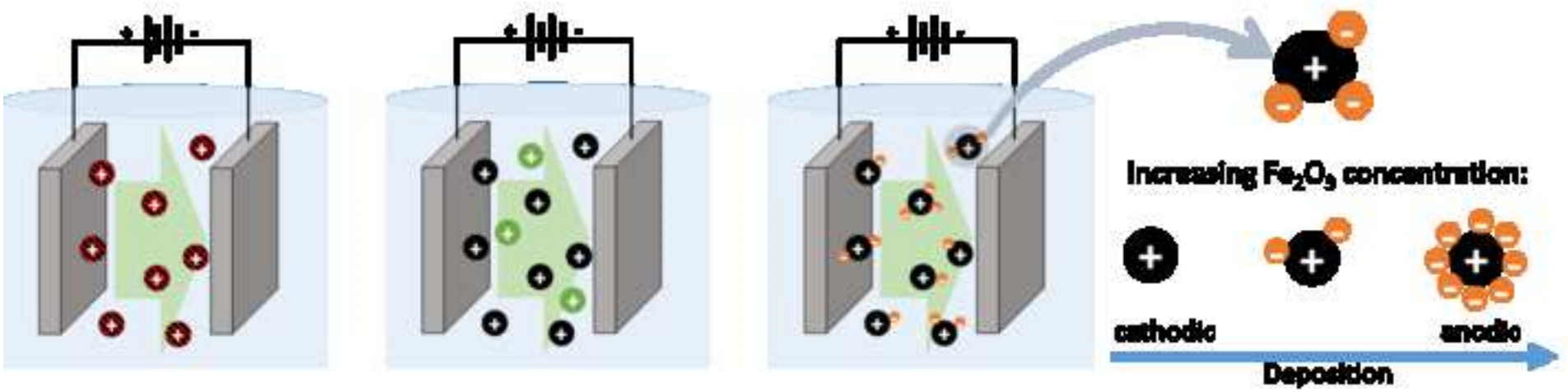
4) Materials in the oxide spinel family have attracted attention thanks to their excellent balance between these characteristics in comparison with rare earth oxides and perovskite must be improve with Eurasian Chemical Communications 2 (2020), 362-373 and Journal of Food Measurement and Characterization volume 14, pages1039-1045(2020)

We thank the reviewer for suggesting the two interesting references. However, considering the requirements and restrictions fixed for the featured letters published in the journal *Materials letters*, we believe that the suggested articles should not be included in the references list. Indeed, the proposed

manuscript focuses on the use of electrophoretic deposition to produce spinel-based protective coatings for SOC interconnects, whereas the suggested references describe the synthesis and testing of nanoparticles as food sensors.

The first paper suggested by reviewer deals with $NiFe_2O_4$ nanoparticles and the second one deals with $MnFe_2O_4$ nanomaterials; anyway, even if we agree with the reviewer about the versatility of spinel compositions, the specific application of these metal oxide nanoparticles is of potential interest as conductive mediators for fabrication of different electrochemical sensors, thus not representing a further data in the specific context of SOCs protective coating applications.

Graphical Abstract



- electrophoretic deposition technique to produce protective coatings for SOC interconnects
- EPD co-deposition approach is a new and an interesting route
- EPD is effective as a versatile deposition method for SOCs protective coating

Recent advances on spinel-based protective coatings for solid oxide cell metallic interconnects produced by electrophoretic deposition

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Keywords: Electrophoretic deposition; Spinel coatings; Solid Oxide Cells.

Abstract

The application of ceramic protective coatings to the metallic interconnects in solid oxide cells (SOC) is a viable and effective method to limit interconnect degradation issues. ~~The aim of t~~This featured letter ~~is to~~ provides ~~present~~ a critical overview of the main outcomes of current research on the use of the electrophoretic deposition (EPD) technique to produce protective coatings for SOC metallic interconnects, specifically focusing on different approaches to stabilise spinel-based suspensions, as well as the possible sintering procedures. The protective properties of EPD coatings are reviewed and discussed in terms of oxidation kinetics and area specific resistance evaluation.

Introduction

Solid oxide cells (SOCs) are electrochemical energy conversion devices operating at temperatures in the range of 500-850 °C. The degradation of metallic interconnects is one of the main issues affecting the durability of SOC. Ceramic protective coatings are widely employed in order to reduce the chromium evaporation and the growth of the under-laying oxide scale on metallic interconnect, which causes an undesired increase of the electrical resistance. The satisfactory performance of a protective coating is strictly related to its high electronic conductivity, thermal expansion coefficient and Cr and O_2-blocking capability. Materials in the oxide spinel family have attracted attention thanks to their excellent balance between these characteristics in comparison with rare earth oxides and perovskites [1]. Among others, manganese-cobalt and manganese-

copper based oxide spinels have been reported to be strong candidates for their high electronic conductivity at the typical SOCs operating temperatures (60-220 S cm^{-1}) and compatible thermal expansion coefficients (10-12 10^{-6} K^{-1}) with metallic materials typically used as interconnects [2]. The properties of these spinels can be tuned ~~adjusted~~ by substituting part of the base elements by transition metals [3,4]. Spinel based coatings have been deposited by various methods, such as sputtering, screen printing, thermal spray, plasma spray, slurry deposition, dip coating and EPD [5,6]. EPD offers the possibility to deposit homogeneous layers in few seconds and at RT condition; moreover, the simple and adaptable setup makes EPD a suitable cost-effective technique for industrial applications. [7]. However, the engineering of the suspensions required for successful EPD, the optimization of the deposition parameters and the choice of appropriate sintering conditions is challenging, as they all contribute to the quality of the obtained coatings [8]. We intend to summarise recent developments on the use of EPD for the fabrication of spinel-based protective coatings for SOC interconnects, highlighting challenges and opportunities ~~and to highlight the advantages and challenges~~ of EPD in such applications.

2. Electrophoretic deposition of spinel coatings

2.1 EPD of manganese-cobalt and manganese-copper spinel

Table 1 reports the EPD parameters for Mn-Co and Mn-Cu spinel-based coatings which have been applied in relevant studies published in the last five years.

		Spinel Coating Material		Electrophoretic deposition					
Ref.	Year	Composition	Synthesis method	Solution [vol%]	Iodine [g/l]	Solid load [g/l]	Voltage [V], time [s]	Electrodes distance [cm]	Substrate
[9]	2015	$Mn_{1.5}Co_{1.5}O_4$	Commercial	60 EtOH 40 H_2O	-	37.5	5-50 V 5-120 s	-	Crofer 22 APU
[10]	2016	$MnCo_2O_4$	Commercial	100 EtOH	0.15	10.0	30-60 V 60-360 s	1	AISI 430
[11]	2017	$Mn_{1.5}Co_{1.5}O_4$	Commercial	60 EtOH 40 H_2O	-	37.5	50 V 20s	1	Crofer 22 APU
[12,13]	2017	$MnCo_2O_4$ $MnCo_{1.7}Fe_{0.3}O_4$ $MnCo_{1.7}Cu_{0.3}O_4$	Spray pyrolysis	50 EtOH 50 IPA	-	39.4	35 V 40-100 s	1.5	Crofer 22 APU
[14]	2018	$MnCo_2O_4$	Commercial	50 EtOH 50 IPA	0.50	7.9	60 V 60 s	-	Crofer 22 APU
[15,16]	2018 2019	$Mn_{1.5}Co_{1.5}O_4$ $Mn_{1.43}Co_{1.43}Cu_{0.14}O_4$ $Mn_{1.35}Co_{1.35}Cu_{0.30}O_4$	Commercial $Mn_{1.5}Co_{1.5}O_4$ and CuO	60 EtOH 40 H_2O	-	37.5	50 V 20 s	1	Crofer 22 APU

[17]	2019	$Mn_{1.5}Co_{1.5}O_4$ $Mn_{1.45}Co_{1.45}Fe_{0.1}O_4$	EDTA	80 ACE 20 IPA	0.50	10	60 V 30 s	1	Crofer 22 H
[18]	2019	$Mn_{1.5}Co_{1.5}O_4$	Commercial	50 EtOH 50 IPA	0.50	15.8	60 V 60 s	-	Crofer 22 APU
[19,20]	2019 2020	$Mn_{1.5}Co_{1.5}O_4$ $Mn_{1.43}Co_{1.43}Fe_{0.14}O_4$ $Mn_{1.35}Co_{1.35}Fe_{0.30}O_4$	Commercial $Mn_{1.5}Co_{1.5}O_4$ and Fe_2O_3	60 EtOH 40 H_2O	-	37.5	50 V 20 s	1	Crofer 22 APU AISI 441
[21]	2020	$MnCo_2O_4$	Commercial	50 EtOH 50 IPA	0.50	15.8	60 V 60 s	1.5	Crofer 22 H AISI 441 AISI430
[22]	2020	$Mn_{1.4}Co_{1.4}Cu_{0.2}O_4$	Commercial	50 IPA 50 ACAC	-	10	40-140 V 2-10 min	-	SUS430
[23]	2017	$Cu_{1.3}Mn_{1.7}O_4$	GNP	75 ACE 25 EtOH	1.09	9	20 V 10 min	1.5	Crofer 22 APU
[24,25]	2018	$CuMn_{1.8}O_4$	GNP	75 ACE 25 EtOH	1.09	9	20 V 10 min	-	Crofer 22 APU Crofer 22 H
[26]	2019	$CuMn_{1.8}O_4$ $Cu_{0.6}Ni_{0.4}Mn_2O_4$	GNP	75 ACE 25 EtOH	1.09	9	20 V 10 min	-	Crofer 22 APU

Table 1: Summary of materials and experimental parameters for the electrophoretic deposition of Mn-Co and Mn-Cu spinel-based coatings for SOC metallic interconnects.

Most of the studies on EPD deposition of spinel coatings have focused on manganese-cobalt spinel. The solvent for preparation of EPD suspension can be composed of fully organic liquids -i.e. ethanol (EtOH), acetone (ACE), isopropanol (IPA), acetylacetone (ACAC) and their mixtures- or partially aqueous solutions. In the first case, the addition of a surface charge enhancer (i.e. I_2) is generally necessary to stabilize the suspension [10,14,17,18,21]. When I_2 is not employed with organic solvents, a stable suspension is made by significantly increasing the particles load of almost 5 times [12,13]. A possible explanation is that when the concentration of solid particles is higher, the electrostatic interactions between particles could have a stabilizing effect toward the suspensions, avoiding their sedimentation. Replacing a certain amount of organic solvent with water (i.e. 40 vol.%) is an eco-friendly solution and does not require the addition of surface charger, due to the presence of sufficient free ions. A possible risk related to the use of water is the development of gas at the electrodes causing a non-homogeneous deposition [7]; however, it is widely reported that an optimal deposition of Mn-Co spinel coating from partially aqueous suspension can occur by applying up to 50 V [9,11,15,16,19,20]. The applied voltage can be higher in the case the solvents are fully organic.

The EPD process typically allows to obtain 10 to 20 µm coatings; this range of thickness is believed to be suitable to act as physical barrier against Cr evaporation and O_2 inward diffusion. Molin et al. [11]

demonstrated the importance to obtain a coating thick enough to limit these phenomena, the EPD Mn-Co coating was more protective than the thin (1-1.5 µm) coatings obtained by both sputtering and thermal co-evaporation method. Although EPD is known to be less influenced by the line-of-sight compared to other techniques, depositions are generally performed on flat coupons in most of the studies. However, the typical design of metallic interconnects employed in SOC stacks exhibits complex shapes and channelled surfaces. To this purpose, Talic et al. [18] recently demonstrated the uniformity of EPD spinel coatings obtained on a channelled sample of Crofer22APU and on a mesh of Crofer22H.

Recently Mn-Cu spinels are receiving increasing attention due to environmental and economic advantages compared to cobalt containing coatings. Furthermore they possess a higher electronic conductivity (up to 100-220 S cm^{-1}, depending on the exact Mn/Cu ratio) than Mn-Co based spinels, together with a CTE highly compatible with Crofer22APU [2]. However, few studies have reported the electrophoretic deposition of Cu-Mn spinel coatings [23–26],~~; EPD parameters are~~ as shown in Table 1. Suspensions of Mn-Cu spinel can be stabilised by employing fully organic liquid media with addition of I_2 in significant concentration (i.e. 1.09 g/l); compared to EPD of Mn-Co spinel; depositions take place at lower applied voltage (20 V against 50-60 V), but remarkably longer time (10 min against 20-60 s). Despite the fact that Mn-Cu spinel-based systems are theoretically more suitable than Mn-Co based ones, to the authors best knowledge, there is a lack in long term tests (>2000h) of these coatings and ~~: i.e.~~ the effect of long~~-~~term~~s~~ exposure to high temperatures on the Cu volatility still needs to be evaluated.

2.2 EPD of copper and iron doped manganese-cobalt spinel

Modifications of the chemical composition of the parent spinel have been identified as an effective strategy to improve the behaviour of Mn-Co spinel, i.e. tuning its CTE, electrical conductivity or sinterability [3,4]. The substitution of a certain percentage of the base spinel elements by transition metals is generally referred as “doping”. The most common dopant elements considered are Fe and Cu; substituted coatings were produced following “ex-situ” or “in-situ” doping approaches.

In the ex-situ approach the modified spinel is synthetized before the coating deposition, employing similar techniques to those of the undoped Mn-Co spinel. For example, Talic et al. [4,12,13] reported on the use of spray pyrolysis to synthetize both undoped and iron or copper doped Mn-Co spinel; Bednarz et al. [17] used a EDTA gel processes instead. In this case, the deposition occurs on the cathode as for the unmodified spinel, as shown in Figure 2 A.

The in-situ doping consists in the co-deposition of the desired amount of the oxide of the additional element (Fe_2O_3, CuO etc.) and of the base spinel (e.g. $Mn_{1.5}Co_{1.5}O_4$). In this case, the homogeneous deposition of the precursors depends on the optimization of the suspension, whereas the subsequent sintering treatment allows the additional element to enter the spinel structure. Sabato et al. [16] co-deposited commercial

$Mn_{1.5}Co_{1.5}O_4$ (d_{50}=634 nm) and CuO (d_{50}=526 nm) producing coatings with different levels of copper doping. Zeta potential measurements showed that both precursors developed a positive surface charge in the selected liquid medium (+13 mV and +6mV respectively), thus leading to cathodic deposition (see Figure 2 B). Zanchi et al. [19,20] produced coatings doped with different amount of iron by co-depositing $Mn_{1.5}Co_{1.5}O_4$ (d_{50}=634 nm) and Fe_2O_3 (d_{50}=75 nm). ~~In this case, l~~iron oxide develops a negative surface charge (-9.9 mV)~~,~~; however, a fully cathodic deposition occurred. Indeed in this case, the electrostatic interactions between opposite charges, the smaller dimension of Fe_2O_3 particles and the low concentration of Fe_2O_3 ~~used~~ led to the co-deposition mechanism schematized in Figure 2 C.

The co-deposition approach ~~proposed is a new and an interesting~~ is an innovative and promising modification route~~: , since the improvement~~ the accomplishment of the in-situ doping could allow to produce multi-layered and multi substituted spinel coatings or with a composition gradient, by simply varying the precursors' concentration in the EPD suspension.

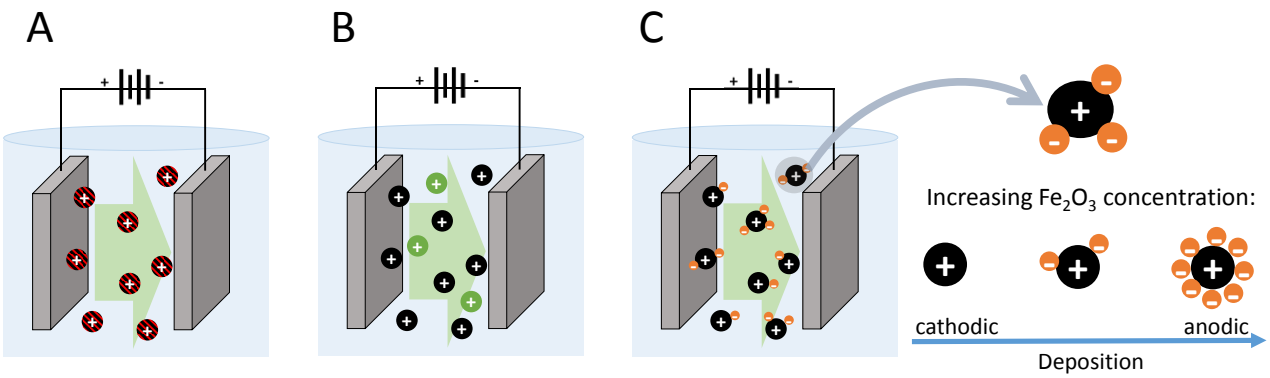


Figure 1: Schematic diagram showing the electrophoretic deposition process of manganese-cobalt spinel-based coatings. A) ex-situ doped spinel; B) in-situ copper doping; C) in-situ iron doping.

3. Evaluation of the sintering parameters

An optimized EPD process allows to deposit homogeneous layers of packed ceramic particles; however, an appropriate sintering treatment is always required in order to obtain a well densified protective coating. The choice of the treatment parameters is crucial: temperature, time and atmosphere of the sintering process should be balanced between the need to obtain a high degree of reaction of the deposited particles and the necessity to avoid the excessive oxidation of the under-laying steel substrate.

Achieving a high densification of the coatings is essential to guarantee an effective barrier behaviour. Indeed, any residual open porosity which constitutes a preferential route for Cr evaporation and oxygen inward migration (Figure 2A) must be avoided, in favour of the formation of a densified coating layer close to the oxide scale and preferably close porosity (Figure 2B) [13].

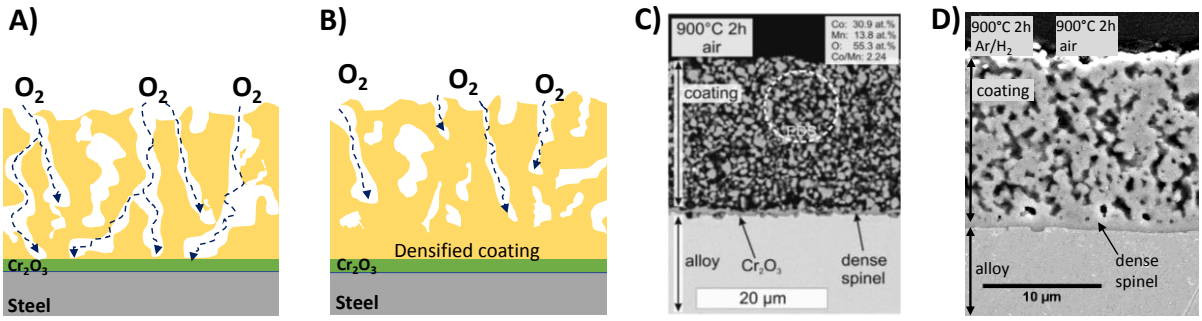


Figure 2: Schematic diagram of EPD coatings: A) sintered non-protective, B) sintered protective coating. C) SEM cross-section view of Mn-Co spinel sintered at 900°C, 2h in air, adapted from [14]; D) SEM cross-section view of Mn-Co spinel sintered at ~~1000~~ 900°C, 2h in Ar/H_2 and at 900°C, 2h in air. Please note the different magnification of the images.

The sintering parameters selected in the discussed studies are summarized in Table 2. A first possibility is to submit the Mn-Co spinel coating to a heat treatment (i.e. 800-900 °C) in oxidizing condition. Nevertheless, the coating densification reached by an oxidizing treatment is generally poor (Figure 2C), unless the heat treatment is performed at very high temperature (i.e. 1100 °C) [14].

It is possible to assert that a two-step sintering approach (consisting of a first heat treatment in reducing atmosphere followed by a second one in oxidising conditions) is widely recognized as a more effective post-deposition treatment for spinel based protective coatings deposited by EPD. In the case of in-situ doped coatings, the two-step sintering is always required and it is normally referred as “reactive sintering”. During the ~~reducing~~ first sintering step, the Mn-Co spinel ~~transform~~ reduces into MnO and Co; in addition, both copper and iron doped coatings form respectively metallic Cu [15,16,22] and Co-Fe intermetallic phase [19]. The re-oxidation treatment allows both the re-formation of the cubic and/or tetragonal phase of the spinel and the introduction of the dopant element; both iron and copper doping are reported to stabilize the cubic structure of Mn-Co spinel [15,16,19]. Thanks to the reduction step, the densification of Mn-Co coating obtained at 900 °C is definitely higher compared to the one-step sintering [14], as shown in Figure 2 C and D. Moreover, the re-oxidation step could easily be performed during the stack consolidation, ~~also~~ considering that the coating in the reduced state is easier to handle than the as-deposited coating.

The two-step sintering procedure can be applied to manganese copper spinel too. In ref. [23] uniaxial pressure was also applied before each heat treatment in order to achieve a sufficient densification; this procedure was then substituted by optimizing the reducing heat treatment (1000°C for 12-24 h) [24–26].

	REF	Sintering parameters			
		Type	**Temperature [°C]**	**Time [h]**	**Atmosphere**
Manganese cobalt spinel	[9]	Oxidizing	800, 1000, 1100	2	Static air
	[10]	Oxidizing	1050	1	Static air
	[11]	Oxidizing	1000	2	Static air
	[12]	Two-step	- 900 - 800	2 2	N_2/H_2 (9 vol.%) Static air
	[13]	Oxidizing	900	2	Static air
		Two-step	- 900, 1100 - 800	2 - 5 2 - 5	N_2/H_2 (9 vol.%) Static air
	[14]	Oxidizing	900, 1000, 1100	2	Static air
		Two-step	- 900, 1000, 1100 - 900	2 2	Ar/H_2 (9 vol.%) Static air
	[15,16]	Two-step	- 900 - 900	2 2	Ar/H_2 (4 vol.%) Static air
	[17]	Two-step	- 900 - 900	2 4	Ar/H_2 (9 vol.%) Static air
	[19,20]	Two-step	- 900, 1000 - 900	2 2	Ar/H_2 (4 vol.%) Static air
	[21]	Oxidizing	900	2	Static air
	[22]	Oxidizing	800	4	Static air
		Two-step	-800	2	Ar/H_2 (5 vol.%)
			-750	2	Static air
Manganese copper spinel	[23]	Two-step	-850* -850*	1 100	Ar/H_2 (2 vol.%) Static air
	[24–26]	Two-step	-1000 -850	12 - 24 100	Ar/H_2 (2 vol.%) Static air
*Uniaxial pressure (from 10 to 100ksi) was applied before the heat treatment					

Table 2: sintering parameters for spinel-based coatings after EPD.

4. Evaluation of the coating properties

The protective properties of coatings for metallic interconnects can be assessed ~~evaluated~~ by ~~the improvement of~~ the oxidation resistance based on thermogravimetric measurements ~~and~~ , the area specific resistance (ASR)~~, as well as~~and the Cr evaporation/migration.

Many studies report that spinel-based coatings exhibit parabolic oxidation, reducing the oxidation rate constant (k_p) of the steel substrate. ~~;~~ ~~T~~the beneficial ~~positive~~ effect of the spinel coatings is generally more prominent at higher aging temperatures. Talic et al. [12] reported that k_p of pre-oxidized Crofer 22 APU at 900°C is one order of magnitude higher than for coated samples; in this case, both ~~all~~ undoped and~~,~~ Cu or Fe-doped $MnCo_2O_4$ spinel coatings obtained by EPD showed no remarkable difference. The same coatings brought less significant improvement on the oxidation resistance when tested at 800°C and 700°C.

However, the joint choice of the steel substrate/coating composition, as well as the evaluation of optimal processing parameters play a major role especially at lower aging temperature. To this purpose, Zanchi et al. [19] found that the oxidation rate of Crofer 22 APU at 750°C is halved by $Mn_{1.5}Co_{1.5}O_4$ coating and reduced by one order of magnitude when a Fe-doped $Mn_{1.5}Co_{1.5}O_4$ spinel coating is applied by EPD and the sintering procedure is optimized. Indeed, the adjustment of the sintering parameters leads to a higher densification of the Fe-doped coating, whose positive influence is confirmed for oxidation tests at 800°C as well [13]. Bednarz et al. [17] studied the oxidation performance of Crofer 22 H, assessing that undoped and Fe-doped $Mn_{1.5}Co_{1.5}O_4$ sequentially reduce the k_p at both 750 and 800 °C. Talic et al. [21] confirmed similar results for Crofer 22 H coated with $MnCo_2O_4$, whereas the performance of cheaper steels, like AISI 441 and AISI 430, does not seem to improve with the same coating compared to the bare substrates.

The measure of ASR can be in continuous (i.e. continuously recorded on samples at high temperature) or discontinuous oxidation (i.e. measurements on pre-oxidised samples) and using different contact materials, e.g. Pt or lanthanum strontium manganite (LSM). The choice of the test method affects the reactions at the interfaces and the determination of the real contact area, thus leading to marked mismatch between the final values. The graph in Figure 3 A presents ASR data (dots) together with aging time (columns) of relevant studies on EPD deposited spinel coatings with various compositions at both 800 and 750°C on different interconnects; when not specified, the reported results are obtained in continuous oxidation and using LSM contacts. It is apparent from this graph that the ASR values from discontinuous measurements with Pt contacts reported in ref. [17] differ significantly from all the other studies; in this case, the high ASR is not due to the uncontrolled growth of the oxide scale, but likely to a poor reaction between coating and contact material, with a consequent overestimation of the real contact area.

The comparison of the ASR values of all reported studies on coated Crofer 22 APU ~~obtained~~ measured in continuous oxidation at 800°C reveals that the coating composition has a minor influence on the long-term conductivity. Indeed, Sabato et al. [16] reported only a slightly lower ASR of Cu-doped $Mn_{1.5}Co_{1.5}O_4$, but for Talic et al. [12] copper doping of $MnCo_2O_4$ did not bring any advantage. ASR measured at 750 °C for both coated Crofer 22 APU and AISI 441 in [20] was moderately higher than at 800°C, in line with the semiconductor-type behaviour (thermally activated electronic conduction) of the spinel coating. Moreover, the final ASR values of both Crofer 22 APU and AISI 441 coated with the same coatings appear completely comparable after 3200 h at 750°C; this suggests that at this temperature the use of low-cost interconnects coupled with effective coatings is definitely convenient. Indeed, Crofer 22 APU is reported to develop the so called “reaction layer” (~~showed in~~ Figure 3 B), causing the progressive increase of the area specific resistance [20]. However, few studies have investigated the long-term ASR of EPD spinel coatings on cheap steel substrates, suitable for intermediate temperature SOCs.

To summarize, the values of k_p and ASR strictly depend on the choice of the testing apparatus and the chosen parameters. For this reason, the comparison of the results from different studies is complex and further research needs to examine more closely the links between the deposition methods and the influence on the final performances of the coatings. For example, Molin et al. [11] assessed that the EPD coating on Crofer 22 APU developed a lower ASR (800°C) than the same spinel coating deposited by sputtering and thermal co-evaporation. On the other hand, various $(Mn,Co)_3O_4$ spinel coatings deposited by sol-gel dip-coating on AISI 430 exhibited an ASR between 11-15 mΩ cm^2 after 1000 h at 800°C [27]~~.; however,~~ Chen at al. [28] obtained a Co-Mn-O spinel coating by a double growth plasma alloying process on AISI 430 and measured an ASR value of 29 mΩ cm^2 (continuous oxidation with Pt contacts) after 408 h at 800°C. Finally, $MnCo_2O_4$ and $MnCo_{1.8}Fe_{0.2}O_4$ coatings on Crofer 22 APU prepared by a two-step impregnation method described in ref. [29] showed an ASR of around 15 mΩ cm^2 after 5000h at 750°C (LSM contacts).

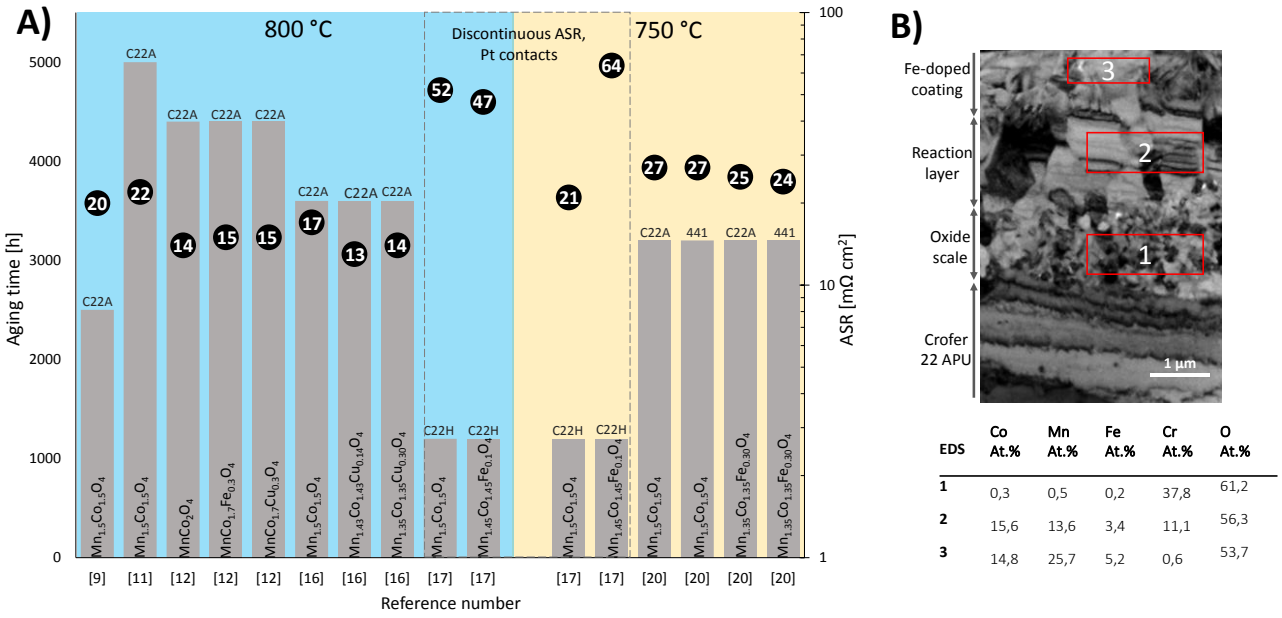


Figure 3: A) Long-term ASR values (dots) with relative aging time (columns) of relevant studies of EPD coatings. Both the coating compositions and the steel substrates are reported on the graph. B) TEM overview of a FIB lamella showing the interface developed between Crofer 22 APU and Fe-doped $Mn_{1.5}Co_{1.5}O_4$ coating after 3200 h at 750 °C.

5. Future perspectives and concluding remarks

All studies reviewed here support the statement that EPD is effective as a versatile deposition method for SOCs protective coating applications~~. Together these studies~~ and provide important insights into the crucial role played by ceramic coatings in solid oxide cells durability and performance. These findings have significant

implications for the understanding of how EPD can be used to design and process new spinel compositions, especially taking advantage of a co-deposition doping procedure and a two-step sintering process. ~~Enhanced efficiency in electrochemical energy conversion can be achieved only by suitable material choice with proper functional requirements.~~ Future research should investigate more deeply the links between deposition method, coating composition and long-term performances, especially for IT-SOC and using low-cost interconnect alloys.

Several aspects of EPD process upscaling for coating large parts remain as future challenges about which relatively little is known. The processing and testing of real dimension plates coated by EPD and tested in a SOC stack is, therefore, an essential ~~next~~ step in confirming EPD as a viable process for spinel-based protective coatings in SOC technologies.

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Figure 1

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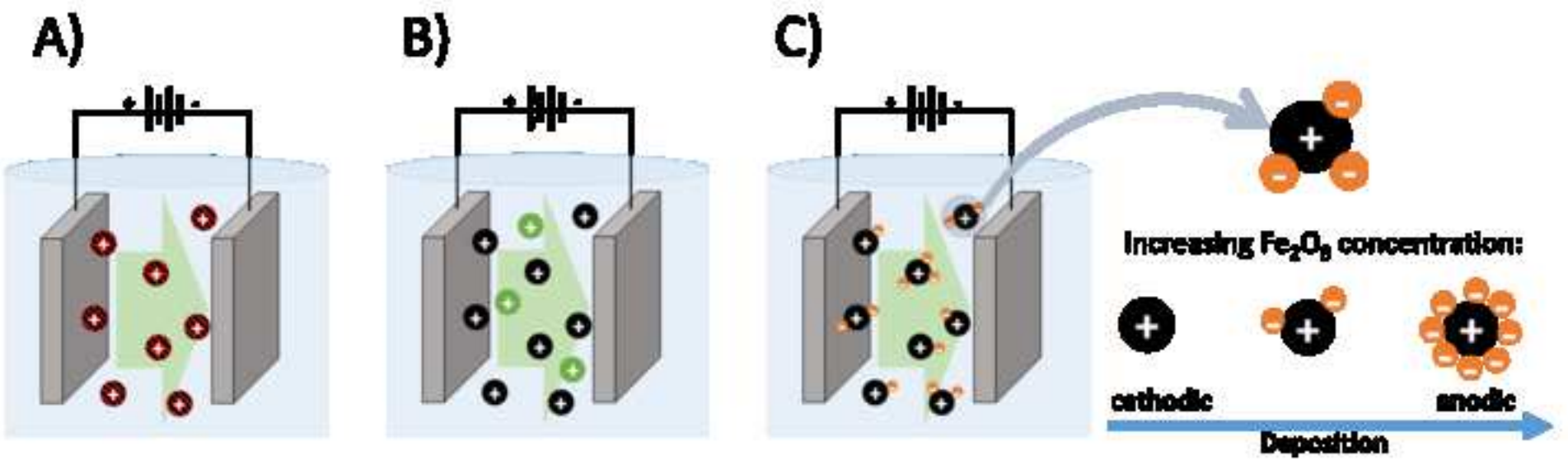


Figure 2

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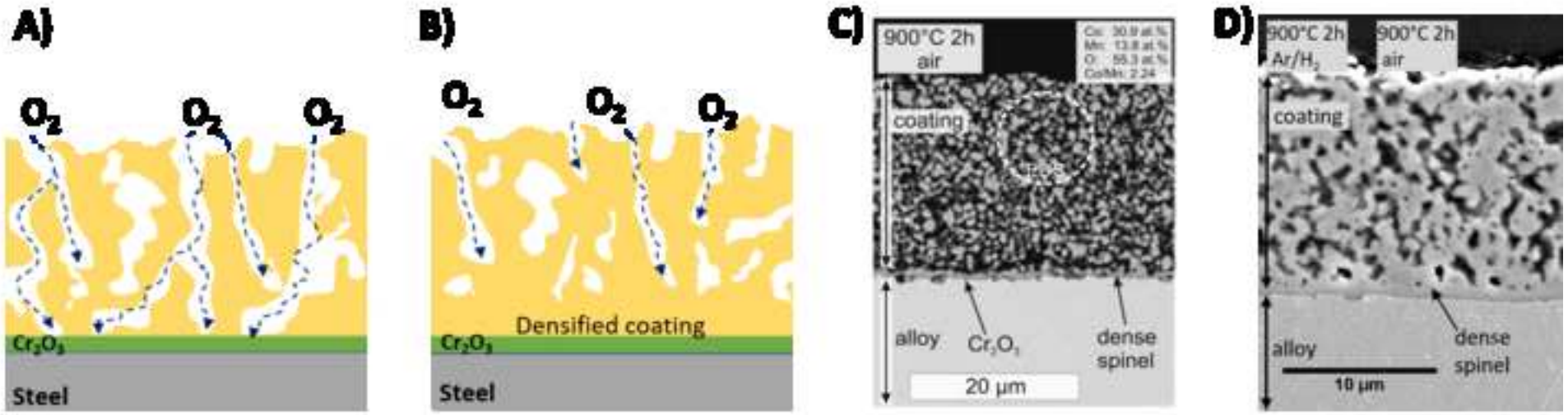


Figure 3

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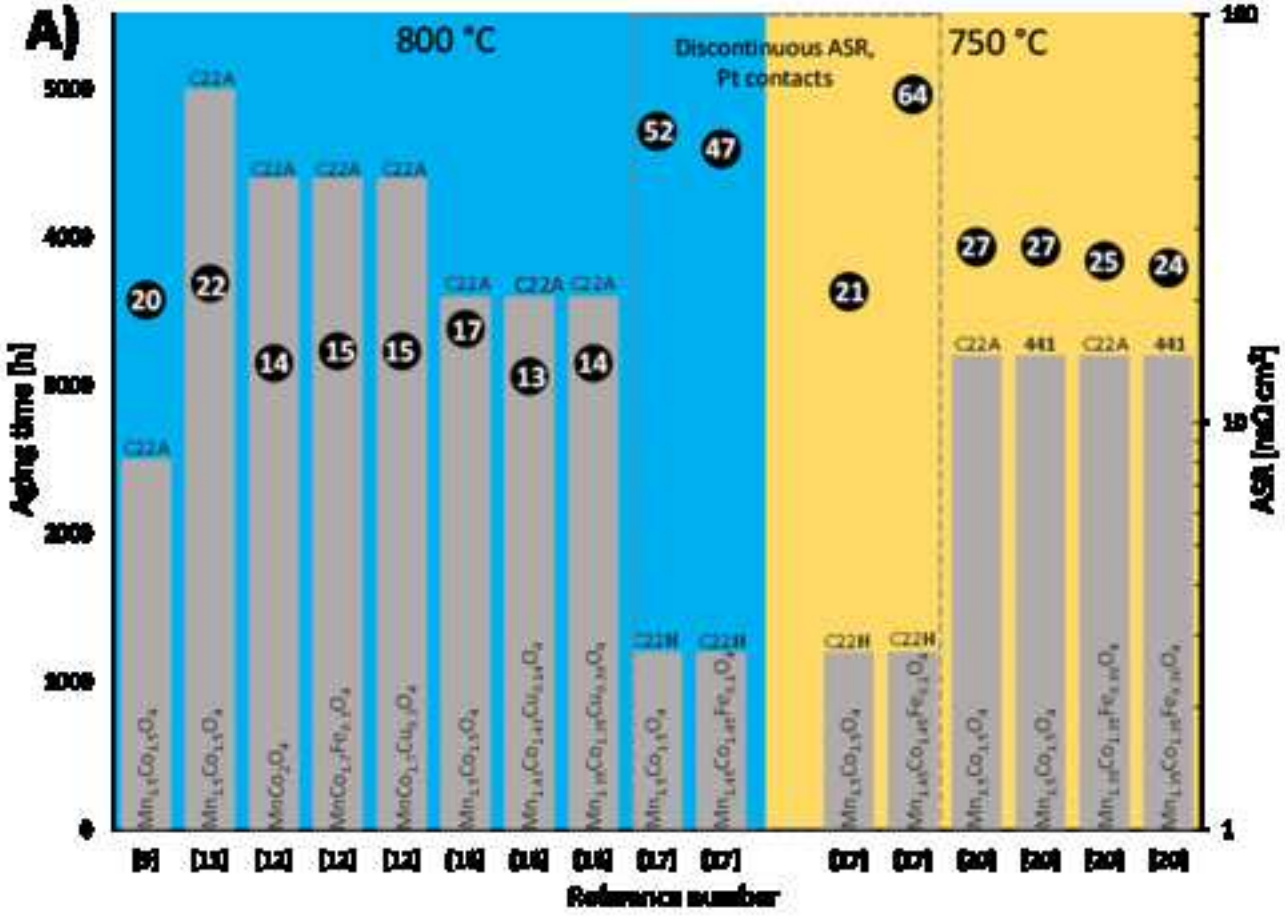


Table 1 rev

Ref.	Year	Spinel Coating Material		Electrophoretic deposition					
		Composition	Synthesis method	Solution [vol%]	Iodine [g/l]	Solid load [g/l]	Voltage [V], time [s]	Electrodes distance [cm]	Substrate
[9]	2015	$Mn_{1.5}Co_{1.5}O_4$	Commercial	60 EtOH 40 H_2O	-	37.5	5-50 V 5-120 s	-	Crofer 22 APU
[10]	2016	$MnCo_2O_4$	Commercial	100 EtOH	0.15	10.0	30-60 V 60-360 s	1	AISI 430
[11]	2017	$Mn_{1.5}Co_{1.5}O_4$	Commercial	60 EtOH 40 H_2O	-	37.5	50 V 20s	1	Crofer 22 APU
[12,13]	2017	$MnCo_2O_4$ $MnCo_{1.7}Fe_{0.3}O_4$ $MnCo_{1.7}Cu_{0.3}O_4$	Spray pyrolysis	50 EtOH 50 IPA	-	39.4	35 V 40-100 s	1.5	Crofer 22 APU
[14]	2018	$MnCo_2O_4$	Commercial	50 EtOH 50 IPA	0.50	7.9	60 V 60 s	-	Crofer 22 APU
[15,16]	2018 2019	$Mn_{1.5}Co_{1.5}O_4$ $Mn_{1.43}Co_{1.43}Cu_{0.14}O_4$ $Mn_{1.35}Co_{1.35}Cu_{0.30}O_4$	Commercial $Mn_{1.5}Co_{1.5}O_4$ and CuO	60 EtOH 40 H_2O	-	37.5	50 V 20 s	1	Crofer 22 APU
[17]	2019	$Mn_{1.5}Co_{1.5}O_4$ $Mn_{1.45}Co_{1.45}Fe_{0.1}O_4$	EDTA	80 ACE 20 IPA	0.50	10	60 V 30 s	1	Crofer 22 H
[18]	2019	$Mn_{1.5}Co_{1.5}O_4$	Commercial	50 EtOH 50 IPA	0.50	15.8	60 V 60 s	-	Crofer 22 APU
[19,20]	2019 2020	$Mn_{1.5}Co_{1.5}O_4$ $Mn_{1.43}Co_{1.43}Fe_{0.14}O_4$ $Mn_{1.35}Co_{1.35}Fe_{0.30}O_4$	Commercial $Mn_{1.5}Co_{1.5}O_4$ and Fe_2O_3	60 EtOH 40 H_2O	-	37.5	50 V 20 s	1	Crofer 22 APU AISI 441
[21]	2020	$MnCo_2O_4$	Commercial	50 EtOH 50 IPA	0.50	15.8	60 V 60 s	1.5	Crofer 22 H AISI 441 AISI430
[22]	2020	$Mn_{1.4}Co_{1.4}Cu_{0.2}O_4$	Commercial	50 IPA 50 ACAC	-	10	40-140 V 2-10 min	-	SUS430
[23]	2017	$Cu_{1.3}Mn_{1.7}O_4$	GNP	75 ACE 25 EtOH	1.09	9	20 V 10 min	1.5	Crofer 22 APU
[24,25]	2018	$CuMn_{1.8}O_4$	GNP	75 ACE 25 EtOH	1.09	9	20 V 10 min	-	Crofer 22 APU Crofer 22 H
[26]	2019	$CuMn_{1.8}O_4$ $Cu_{0.6}Ni_{0.4}Mn_2O_4$	GNP	75 ACE 25 EtOH	1.09	9	20 V 10 min	-	Crofer 22 APU

Table 2

	REF	Sintering parameters			
		Type	**Temperature [°C]**	**Time [h]**	**Atmosphere**
Manganese cobalt spinel	[9]	Oxidizing	800, 1000, 1100	2	Static air
	[10]	Oxidizing	1050	1	Static air
	[11]	Oxidizing	1000	2	Static air
	[12]	Two-step	- 900 - 800	2 2	N_2/H_2 (9 vol.%) Static air
	[13]	Oxidizing	900	2	Static air
		Two-step	- 900, 1100 - 800	2 - 5 2 - 5	N_2/H_2 (9 vol.%) Static air
	[14]	Oxidizing	900, 1000, 1100	2	Static air
		Two-step	- 900, 1000, 1100 - 900	2 2	Ar/H_2 (9 vol.%) Static air
	[15,16]	Two-step	- 900 - 900	2 2	Ar/H_2 (4 vol.%) Static air
	[17]	Two-step	- 900 - 900	2 4	Ar/H_2 (9 vol.%) Static air
	[19,20]	Two-step	- 900, 1000 - 900	2 2	Ar/H_2 (4 vol.%) Static air
	[21]	Oxidizing	900	2	Static air
	[22]	Oxidizing	800	4	Static air
		Two-step	-800	2	Ar/H_2 (5 vol.%)
			-750	2	Static air
Manganese copper spinel	[23]	Two-step	-850* -850*	1 100	Ar/H_2 (2 vol.%) Static air
	[24–26]	Two-step	-1000 -850	12 - 24 100	Ar/H_2 (2 vol.%) Static air

*Uniaxial pressure (from 10 to 100ksi) was applied before the heat treatment

Declaration of interests

☒ The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

☐The authors declare the following financial interests/personal relationships which may be considered as potential competing interests:

Credit Author Statement

Elisa Zanchi: Writing - Original Draft, Investigation, Data curation

A.G. Sabato: Data curation, Investigation, Conceptualization

S. Molin: Data curation, Investigation, Conceptualization

G. Cempura: : Investigation, Data Curation

A. R. Boccaccini: Reviewing and Editing

F. Smeacetto: Writing- Reviewing and Editing, Conceptualization, Supervision